



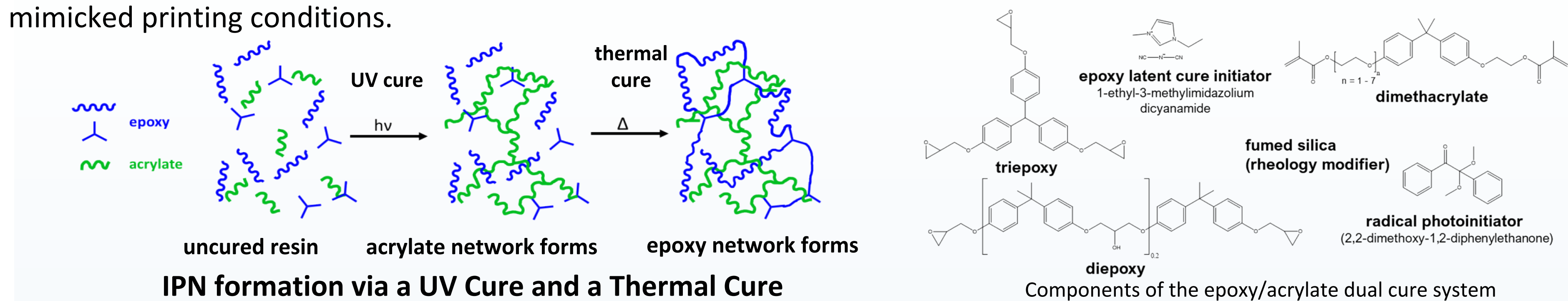
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## Objective: Using Photorheology with Thermosets for Direct Ink Write and Vat Polymerization Printing

Determine if we can use photorheology to achieve printability of resin formulations as well as see how the kinetics differ when changing stoichiometries, without having to use a significant amount of resin to empirically determine optimal print parameters.

## Dual-Cure System Photorheology

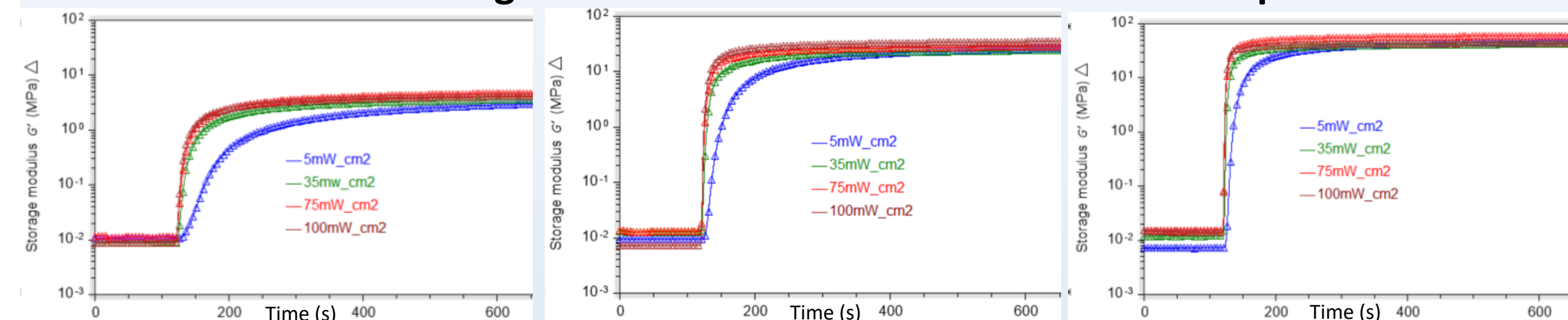
**INTRO:** Dual cure systems contain components cured by UV irradiation and a thermal cure to develop a stronger Interpenetrating Polymer Network (IPN). Our dual-cure system consists of a dimethacrylate that rapidly cures via in situ UV irradiation to help maintain the structure during Direct Ink Write (DIW) printing. The second component is a homopolymerized epoxy which is thermally cured post-print to achieve a stronger IPN. Using different weight percents (wt%) of acrylate, along with UV dose, we can determine the rate of cure and how a formulation will perform under mimicked printing conditions.



### IPN formation via a UV Cure and a Thermal Cure

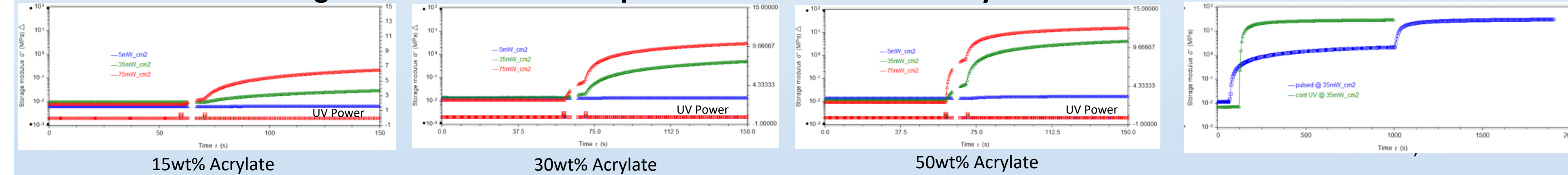
**RESULTS:** Using photorheology we can determine how the UV irradiation step is forming the acrylate network, which is needed for DIW. The intensity of UV (@365 nm) determines the rate of cure. Using photorheology we can use a very small amount of resin to determine the kinetics and change stoichiometries to find the optimal resin for DIW printing.

### Plots of Storage Modulus vs Time for Continuous UV Exposures



With photorheology we can see how using different UV intensities effects the cure kinetics and final modulus of each of our wt% formulations. Each test is run with a 25 min continuous UV exposure.

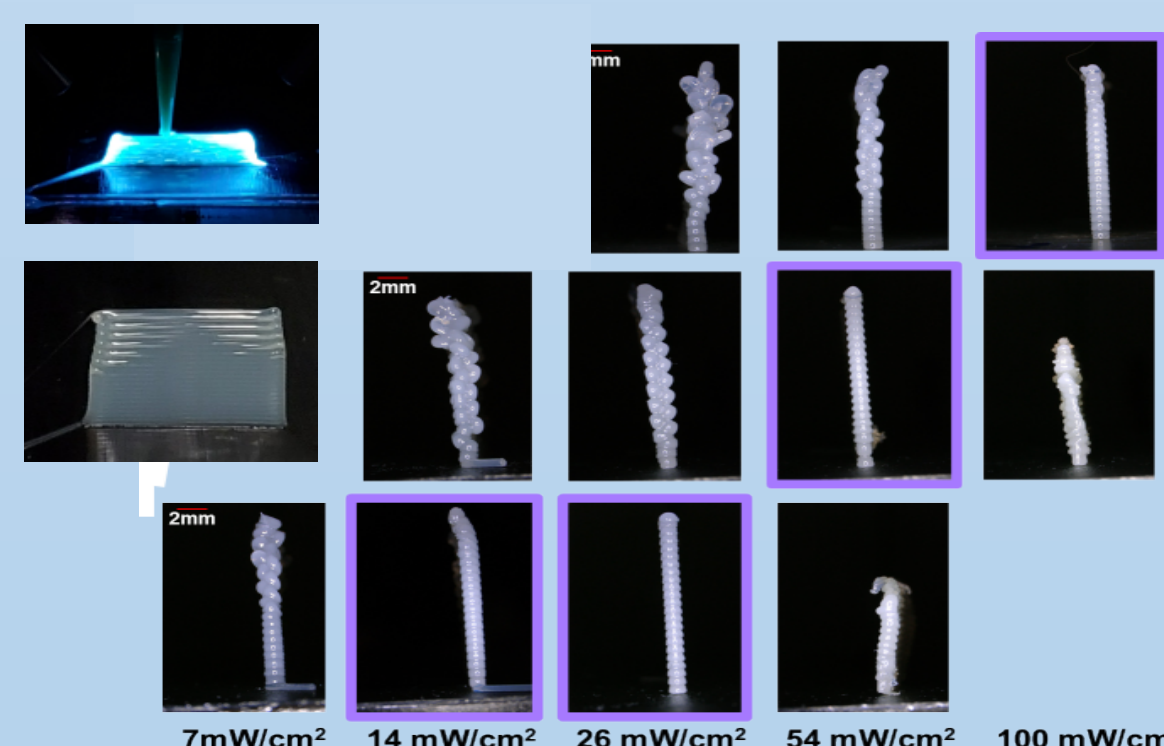
### Plots of Storage vs Modulus Pulsed Exposures of different wt% Acrylate



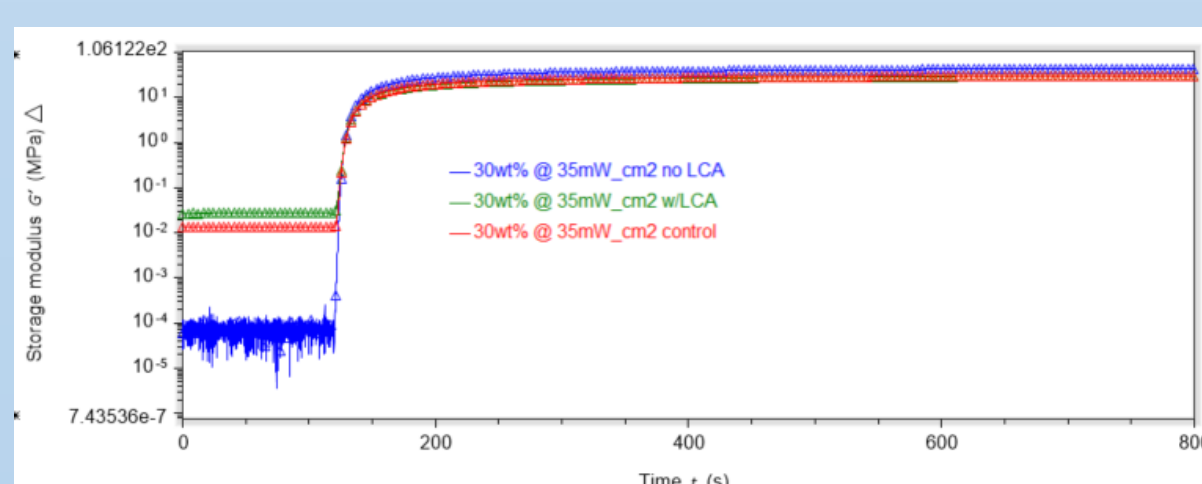
Using photorheology we are able to mimic printing exposure profiles, which vary based on geometry and print path. Plots show the first 150 seconds of a pulsed exposure with two 1 second pulses of UV light separated by 10 second dark times followed by a 15 min dark time.

The addition of fumed silica increases the viscosity of our formulation to enable DIW printing, which is a versatile form of additive manufacturing. With dual cure systems we can improve interlayer adhesion better than single cure formulations due to the IPN forming between layers which improves the overall strength.

### Interlayer Adhesion of Acrylate wt% @ Differing Intensities

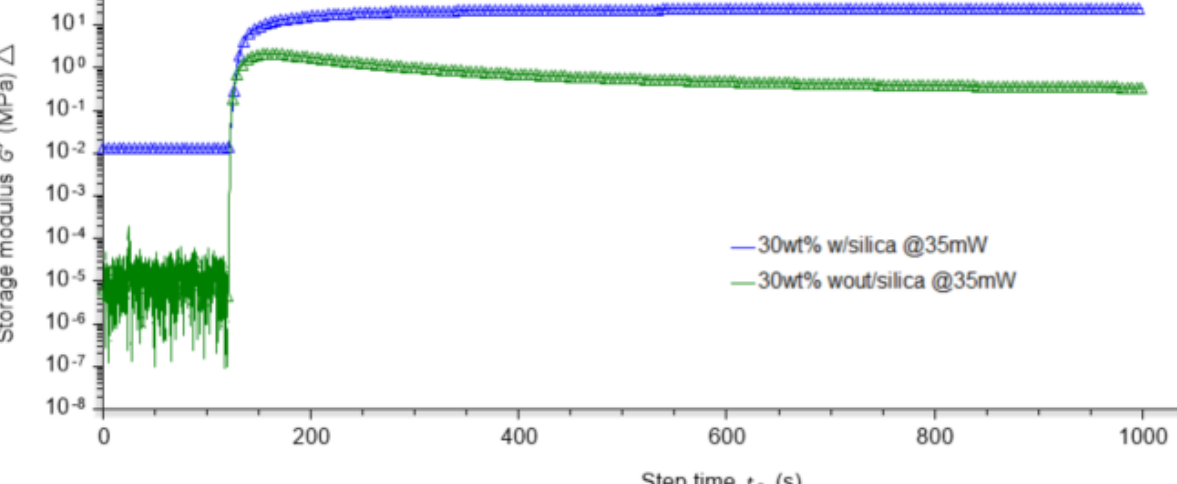


### Using Photorheology to Determine Component Effects



Removal of the epoxy latent cure initiator lowers the initial viscosity, but does not impact the cure or final modulus.

### Cont. UV vs Pulsed



The removal of silica reduces the initial viscosity and the final modulus, but does not significantly impact the cure kinetics.

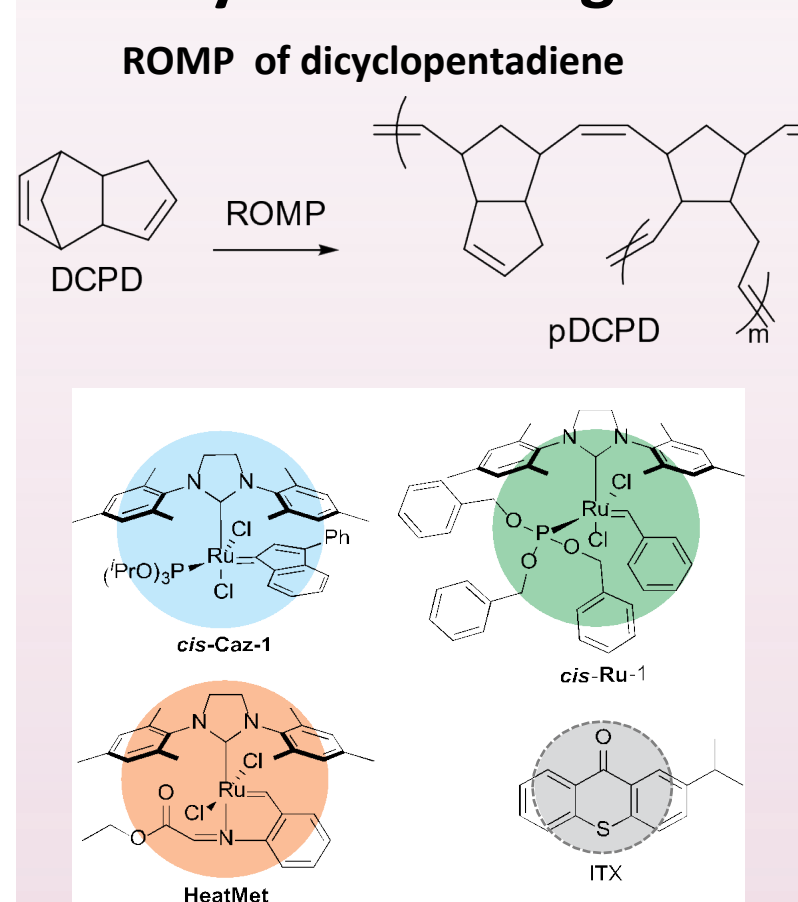
After successfully developing this dual cure formulation for DIW we are now looking at unfilled formulations for Vat Polymerization (VP). We are also interested in printing with a single cure system using photorheology to screen formulations.

## Single Cure System Photorheology

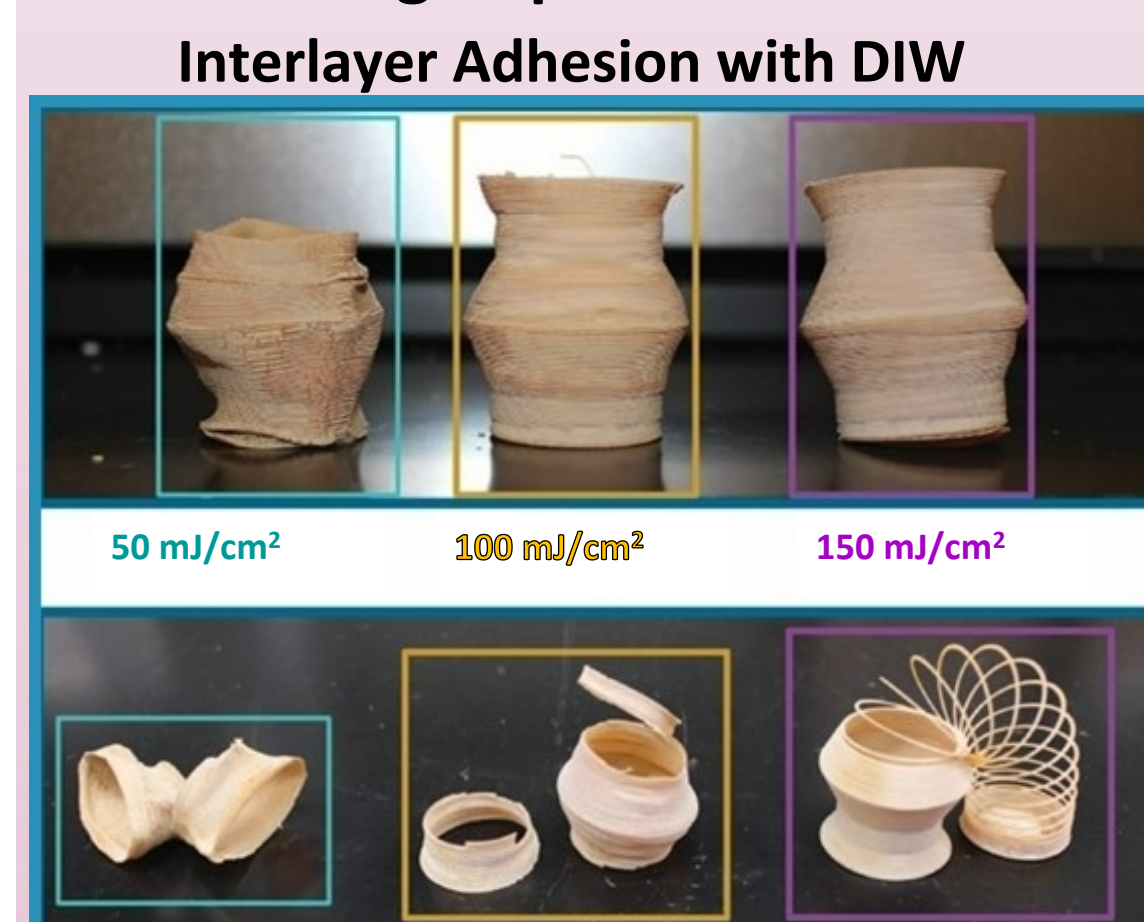
**INTRO:** Our second system uses Ring Opening Metathesis Polymerization (ROMP) of dicyclopentadiene (DCPD) with photoinitiated catalysts. This system has a high strength and toughness but the rate of polymerization with Ru catalysts alone is too slow for practical DIW and Vat Polymerization printing (VP). With the addition of a photosensitizer, isopropylthioxanthone (ITX), we are able to achieve a high rate of polymerization perfect for DIW and VP. UV Rheology allows us to screen catalysts and photosensitizers without actually having to print.

**RESULTS:** The addition of photosensitizer ITX increases the rate of reaction dramatically with each catalyst, especially HeatMet. However the HeatMet system has a potlife of only about 3 hours which is not ideal for VP.

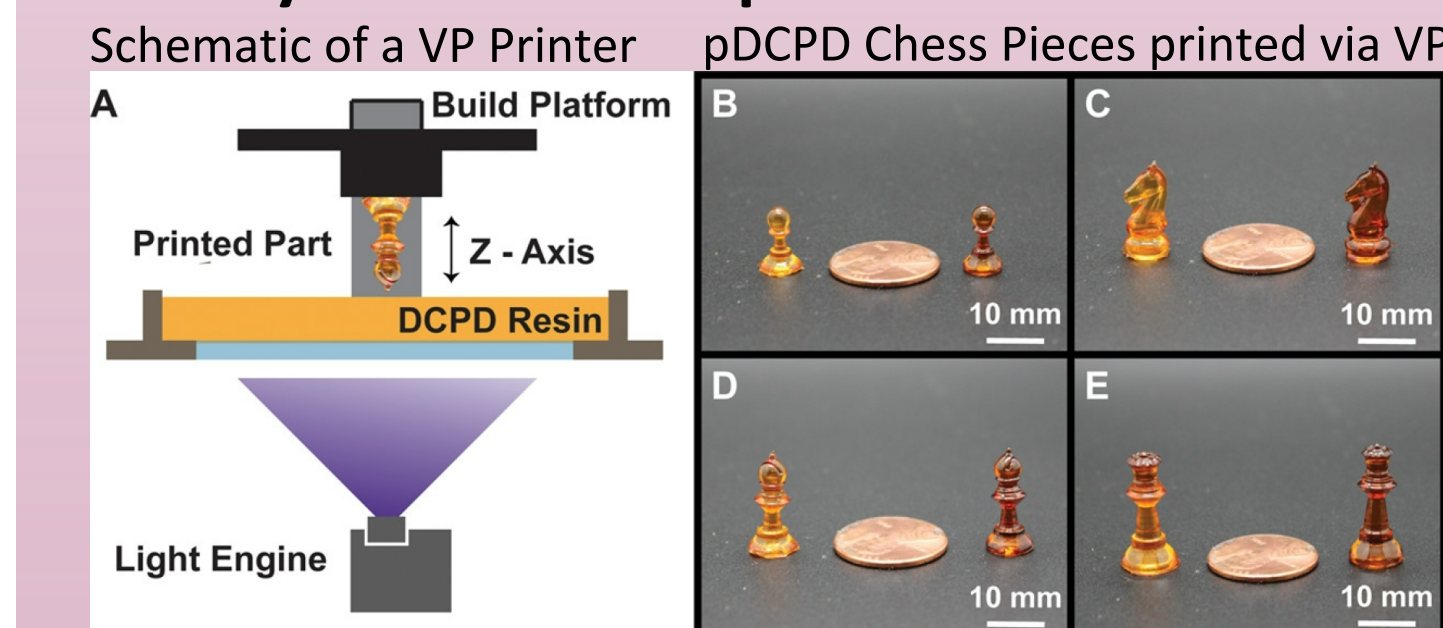
### Catalyst Screening



### DIW Printing of pDCPD



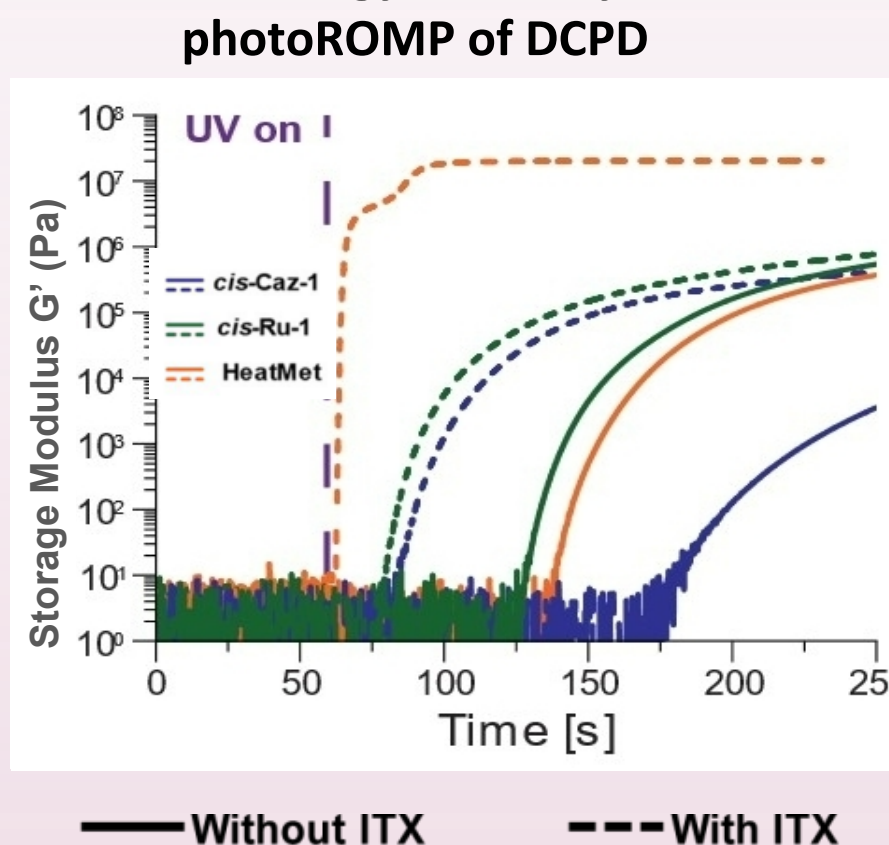
### Vat Polymerization of pDCPD



VP printing enables printing of parts with much higher resolution than DIW.

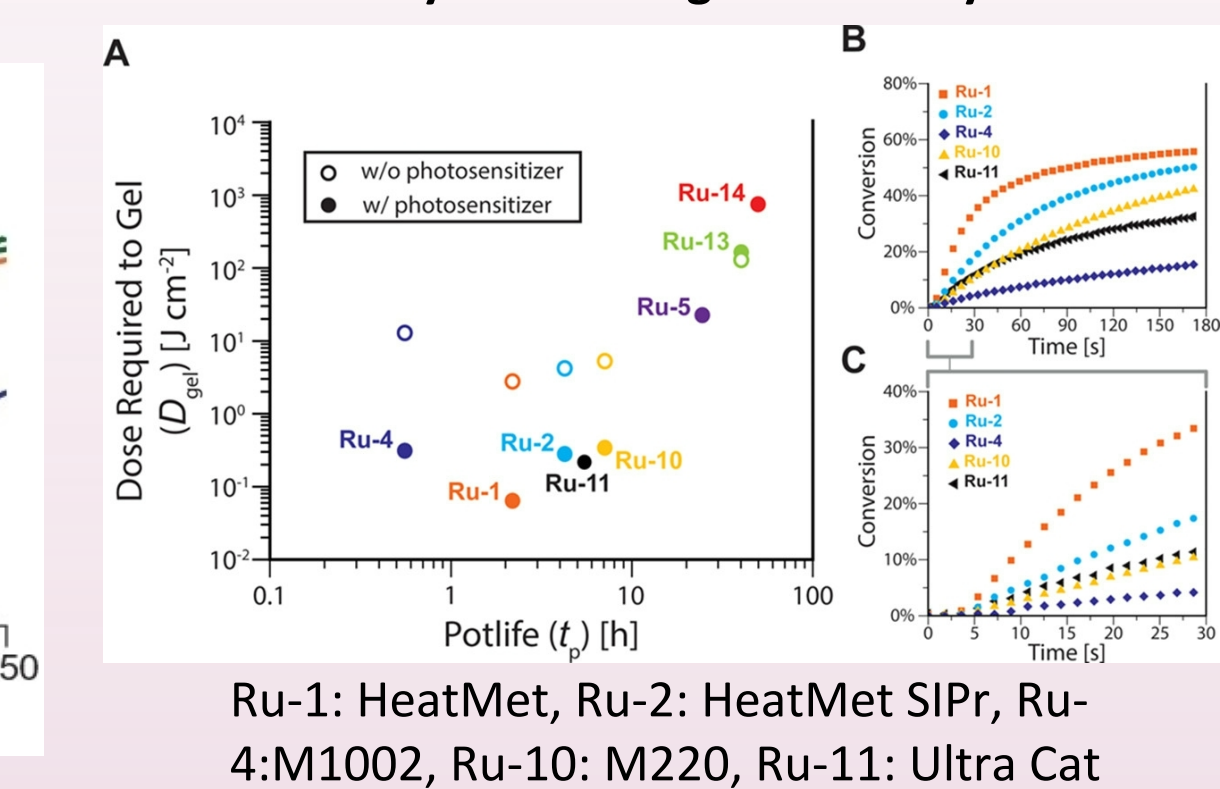
Pieces on the left were VP printed with benzil/Ru-11 and on right with benzophenone/Ru-10

### Photoreology of Catalysts for photoROMP of DCPD

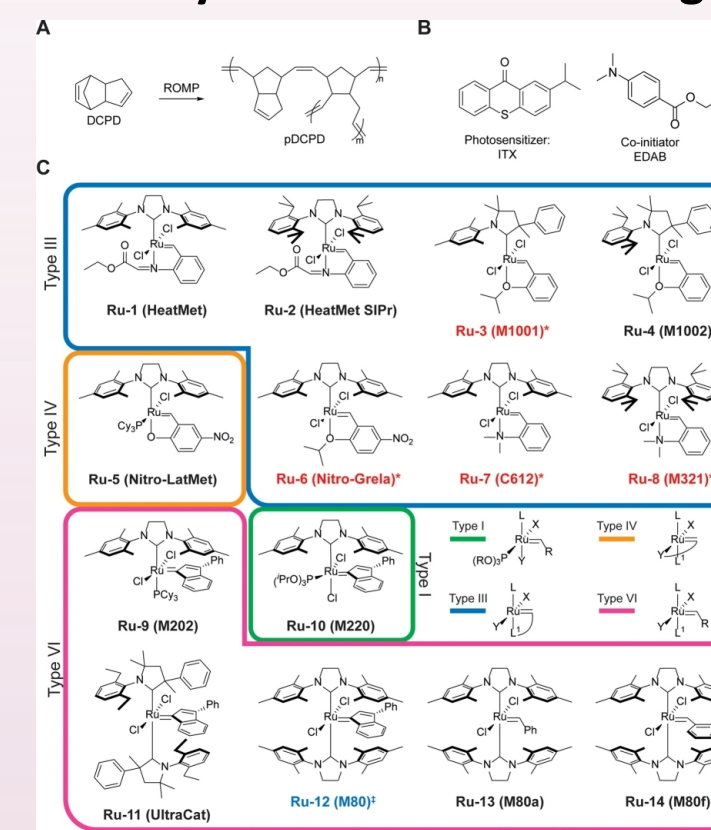


Even though HeatMet has the smallest dose requirement the potlife is relatively short which makes VP printing with HeatMet challenging. By using photorheology to quickly screen many catalysts we have been able to determine that Ru-10 and 11 optimize required dose and potlife for VP printing.

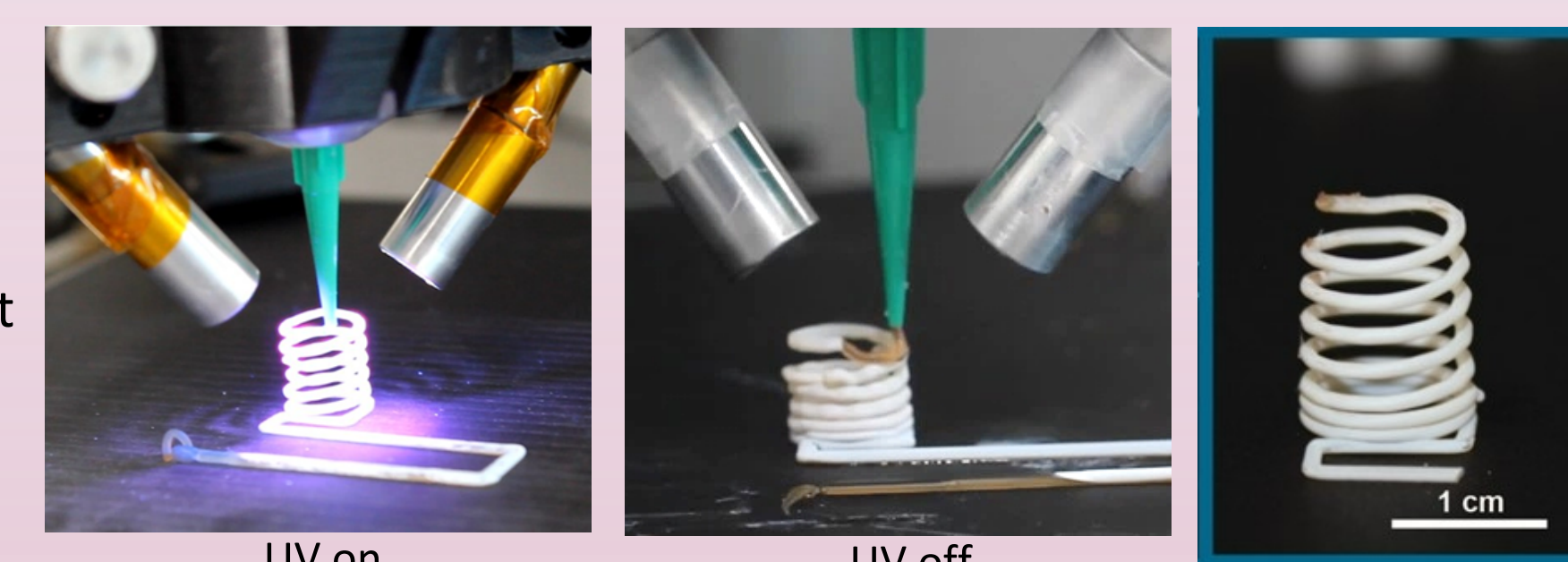
### Ruthenium Catalyst Screening for Vat Polymerization



### Catalysts Used for Screening



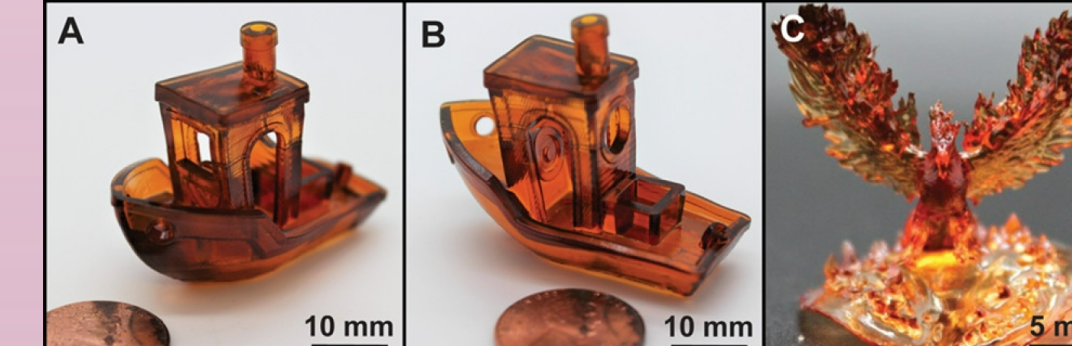
### Skywriting pDCPD with photoROMP



Turning UV on and off during free space printing shows that the ROMP is photocontrolled, and not a photoinitiated frontal polymerization (FROMP).

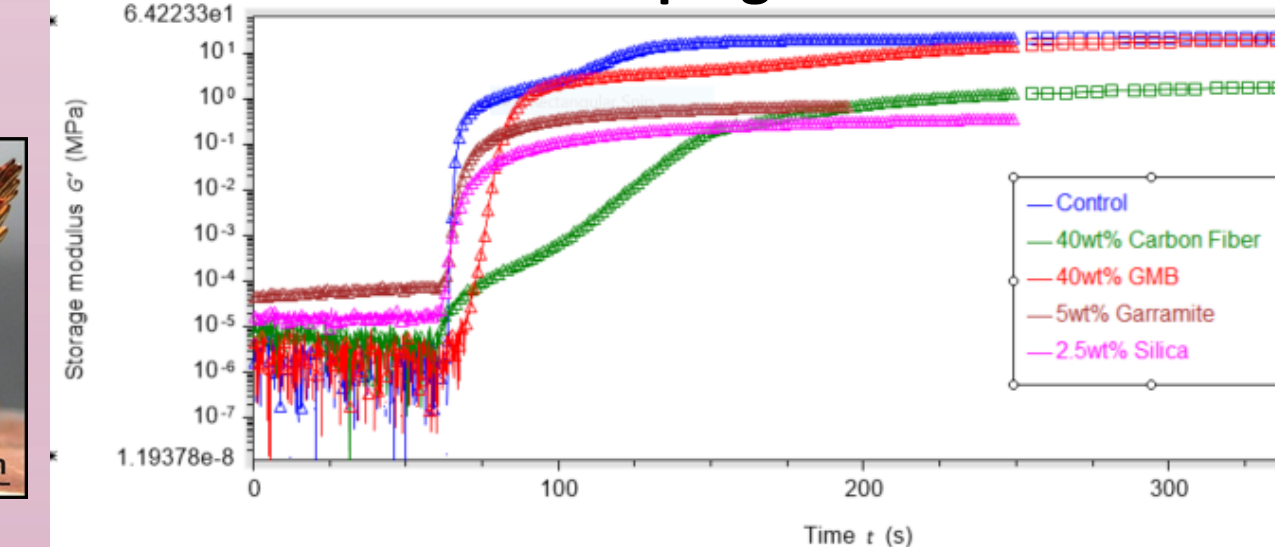
Using the optimized formulations identified by screening with photorheology we were also able to demonstrate vat polymerization printing of pDCPD.

### pDCPD objects printed via VP



Boat printed using benzophenone/Ru-10 and phoenix printed using benzil/Ru-11 formulation

### Future Work: Developing filled resins for VP



Photorheology allows us to see how different fillers impact our printable resin formulations.

**Conclusions and Future Work:** Using photorheology we are able to quickly develop our thermoset polymers in order to find the formulations and printing parameters needed for Direct Ink Write and Vat Polymerization printing. With photoROMP of DCPD we were able to achieve a system that could DIW as well as VP print. The development of these formulations would have taken much more time and material without photorheology.

**Future work includes:** 1) Vat polymerization of pDCPD with fillers to determine how they change our current formulation 2) Vat polymerization with Epoxy/Acrylate formulations

See also: Epoxy/acrylate dual-cure: J.W. Kopatz, J. Unangst, A.W. Cook, L.N. Appelhans\* *Additive Manufacturing*, 2021, 46, 102159

PhotoROMP DIW: Leguizamon, S. C.; Cook, A. W.; Appelhans, L. N.\* *Chemistry of Materials* 2021, 33 (24), 9677-9689

Photoinitiated Olefin Metathesis and Stereolithographic Printing of Polydicyclopentadiene: Leguizamon, S. C.\*; Monk, N. T.; Hochrein, M. T.; Zapfen, E. M.; Yoon, A.; Foster, J. C.; Appelhans, L. N.\*\*